imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









DGD2103A

HALF-BRIDGE GATE DRIVER IN SO-8

Description

The DGD2103A is a high-voltage, high-speed gate driver capable of driving N-channel MOSFETs and IGBTs in a half-bridge configuration. High-voltage processing techniques enable the DGD2103A's high side to switch to 600V in a bootstrap operation.

The DGD2103A logic inputs are compatible with standard TTL and CMOS levels (down to 3.3V) to interface easily with controlling devices. The driver outputs feature high pulse current buffers designed for minimum driver cross conduction. The DGD2103A has a fixed internal deadtime of 520ns (typical).

The DGD2103A is offered in SO-8 (Type TH) package and operates over an extended -40°C to +125°C temperature range.

Applications

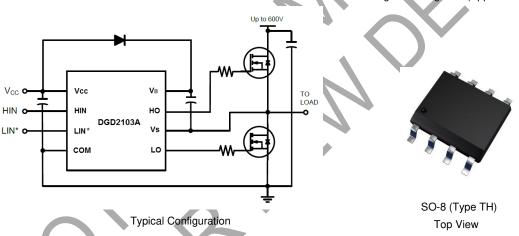
- **DC-DC Converters**
- **DC-AC Inverters**
- AC-DC Power Supplies
- Motor Controls
- **Class D Power Amplifiers**

Features

- Floating High-Side Driver in Bootstrap Operation to 600V
- Drives Two N-channel MOSFETs or IGBTs in a Half Bridge Configuration
- 210mA Source / 360mA Sink Output Current Capability
- **Outputs Tolerant to Negative Transients**
- Internal Dead Time of 520ns to Protect MOSFETs
- Wide Low Side Gate Driver Supply Voltage: 10V to 20V
- Logic Input (HIN and LIN*) 3.3V Capability
- Schmitt Triggered Logic Inputs
- Undervoltage Lockout for V_{CC} (Logic and Low Side Supply)
- Extended Temperature Range: -40°C to +125°C
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony free. "Green" Device (Note 3)

Mechanical Data

- Case: SO-8 (Type TH)
- Case Material: Molded Plastic. "Green" Molding Compound UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.075 grams (Approximate)



Ordering Information (Note 4)

Part Number	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
DGD2103AS8-13	DGD2103A	13	12	2,500

No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (ROHS) & 2011/05/EU (ROHS 2) compliant. 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

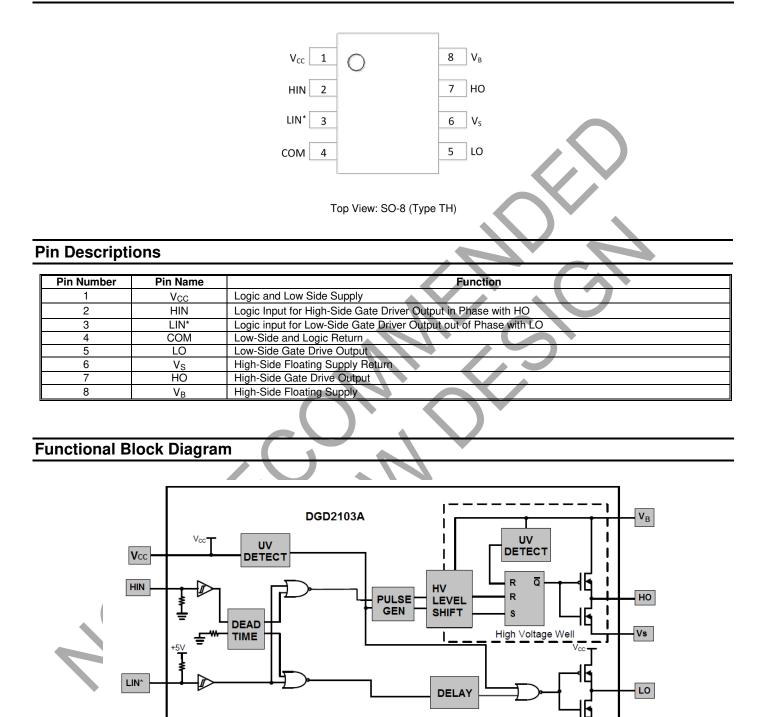
Marking Information



= Manufacturer's Marking ייר DGD2103A = Product Type Marking Code YΥ = Year (ex: 16 = 2016) ww = Week (01 to 53)



Pin Diagrams



Ē

СОМ

Ψ



DGD2103A

Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
High-Side Floating Supply Voltage	VB	-0.3 to +624	V	
High-Side Floating Supply Offset Voltage	Vs	V _B -24 to V _B +0.3	V	
High-Side Floating Output Voltage	V _{HO}	V _S -0.3 to V _B +0.3	V	
Offset Supply Voltage Transient	dV _S / dt	50	V/ns	
Low-Side Fixed Supply Voltage	V _{CC}	-0.3 to +24	V	
Low-Side Output Voltage	V _{LO}	-0.3 to V _{CC} +0.3	V	
Logic Input Voltage (HIN and LIN*)	V _{IN}	-0.3 to V _{CC} +0.3	V	

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation Linear Derating Factor (Note 5)	PD	0.625	W
Thermal Resistance, Junction to Ambient (Note 5)	R _{θJA}	200	°C/W
Operating Temperature	TJ	+150	
Lead Temperature (Soldering, 10s)	TL	+300	°C
Storage Temperature Range	T _{STG}	-55 to +150	

Note: 5. When mounted on a standard JEDEC 2-layer FR-4 board.

Recommended Operating Conditions

				*	
Parameter		Symbol	Min	Max	Unit
High-Side Floating Supply Absolute Voltage	VB	V _S + 10	V _S + 20	V	
High-Side Floating Supply Offset Voltage		Vs	(Note 6)	600	V
High-Side Floating Output Voltage		V _{HO}	Vs	VB	V
Low-Side and Logic Fixed Supply Voltage		V _{CC}	10	20	V
Low-Side Output Voltage		VLO	0	Vcc	V
Logic Input Voltage		VIN	0	5	V
Ambient Temperature		TA	-40	+125	°C

Note: 6. Logic operation for V_S of -5V to +600V. Logic state held for V_S of -5V to - V_{BS} .





DGD2103A

DC Electrical Characteristics (V_{BIAS} (V_{CC} , V_{BS}) = 15V, @T_A = +25°C, unless otherwise specified.) (Note 7)

Parameter	Symbol	Min	Тур	Max	Unit	Condition
Logic "1" (HIN) & Logic "0" (LIN*) Input Voltage	V _{IH}	2.5	-	-	V	$V_{CC} = 10V$ to 20V
Logic "0" (HIN) & Logic "1" (LIN*) Input Voltage	V _{IL}	-	-	0.8	V	$V_{CC} = 10V$ to 20V
High-Level Output Voltage, V _{BIAS} - V _O	V _{OH}	-	0.05	0.2	V	$I_0 = 2mA$
Low-Level Output Voltage, V _O	V _{OL}	-	0.02	0.1	V	$I_O = 2mA$
Offset Supply Leakage Current	I _{LK}	-	-	50	μA	$V_{B} = V_{S} = 600V$
Quiescent V _{BS} Supply Current	IBSQ	-	30	55	μA	$V_{IN} = 0V \text{ or } 5V$
Quiescent V _{CC} Supply Current	ICCQ	-	370	500	μA	$V_{IN} = 0V \text{ or } 5V$
Logic "1" Input Bias Current	I _{IN+}	-	3.0	10	μA	$HIN = 5V, LIN^* = 0V$
Logic "0" Input Bias Current	I _{IN-}	-	-	5.0	μA	$HIN = 0V, LIN^* = 5V$
V _{CC} Supply Under-Voltage Positive Going Threshold	V _{CCUV+}	8.0	8.9	9.8	V	-
V _{CC} Supply Under-Voltage Negative Going Threshold	V _{CCUV-}	7.4	8.2	9.0	V	
Output High Short Circuit Pulsed Current	I _{O+}	130	210	_	mA	V _O = 0V, PW ≤ 10µs
Output Low Short Circuit Pulsed Current	I _{O-}	270	360	-	mA	V _O = 15V, PW ≤ 10µs

Note: 7. The V_{IN} and I_{IN} parameters are applicable to the two logic pins: HIN and LIN*. The V_O and I_O parameters are applicable to the respective output pins: HO and LO.

AC Electrical Characteristics (V_{BIAS} (V_{CC}, V_{BS}) = 15V, C_L = 1000pF, @T_A = +25°C, unless otherwise specified.)

Parameter	Symbol	Min	Тур	Max	Unit	Condition
Turn-On Propagation Delay	t _{ON}	7	680	820	ns	$V_{\rm S} = 0V$
Turn-Off Propagation Delay	toff		150	220	ns	$V_{\rm S} = 600 V$
Delay Matching, HO & LO Turn-On / Turn-Off	t _{DM}	_		60	ns	-
Turn-On Rise Time	t _R	-	100	170	ns	$V_{\rm S} = 0V$
Turn-Off Fall Time	t⊧		50	60	ns	$V_{\rm S} = 0V$
Deadtime: t _{DT LO-HO} & t _{DT HO-LO}	t _{DT}	400	520	650	ns	-





DGD2103A

90%

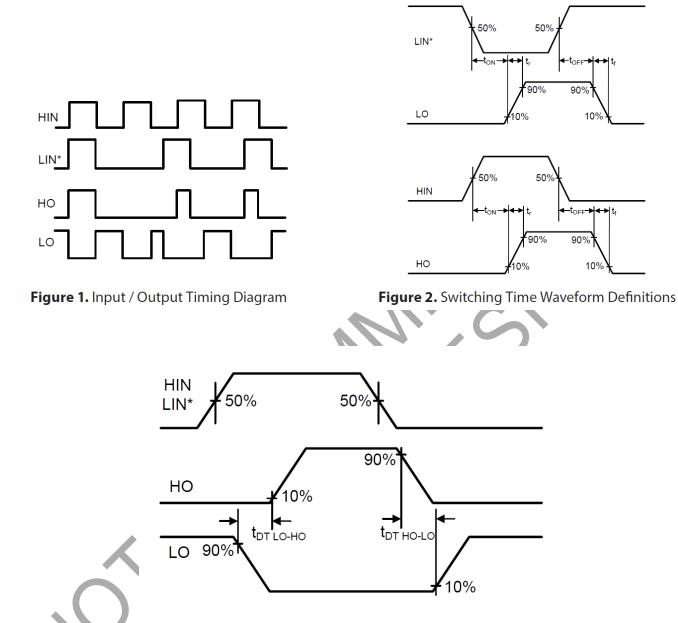
10%

-t_{OFF}→| ← → | t_f

10%

90%

Timing Waveforms







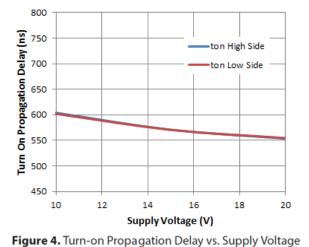
800

750

DGD2103A

ton High Side

Typical Performance Characteristics (@TA = +25°C, unless otherwise specified.)



Turn On Propagation Delay (ns) 700 ton Low Side 650 600 550 500 450 -20 0 20 40 60 80 100 120 -40 Temperature (°C) Figure 5. Turn-on Propagation Delay vs. Temperature

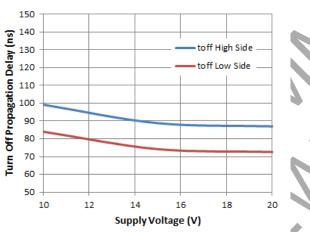


Figure 6. Turn-off Propagation Delay vs. Supply Voltage

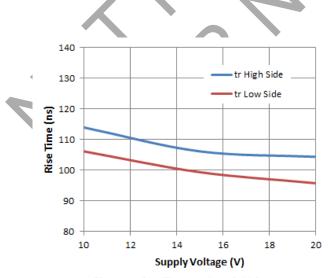


Figure 8. Rise Time vs. Supply Voltage

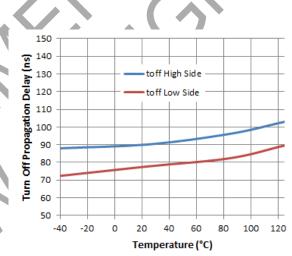


Figure 7. Turn-off Propagation Delay vs. Temperature

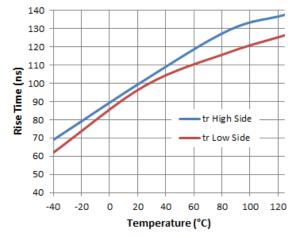


Figure 9. Rise Time vs. Temperature



Typical Performance Characteristics (Cont.)

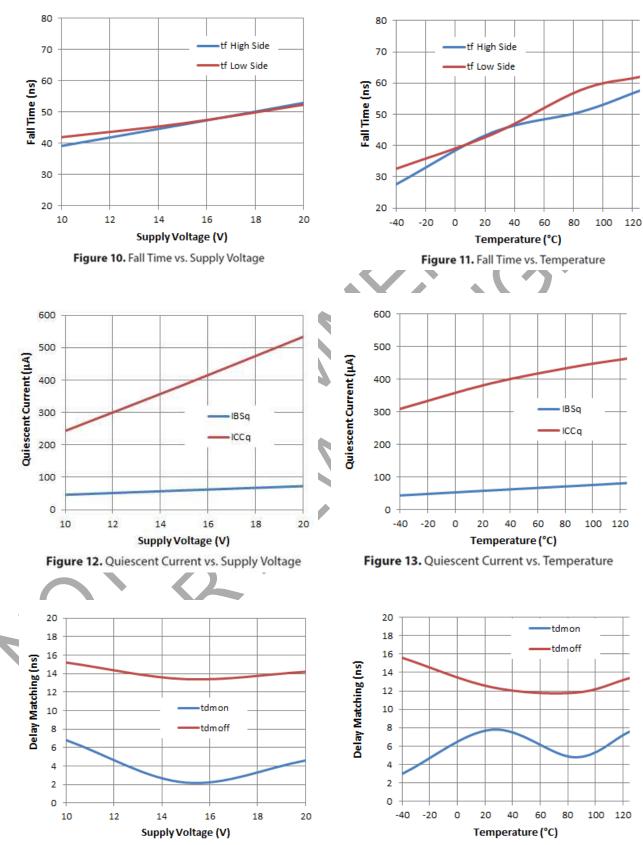


Figure 15. Delay Matching vs. Temperature



DGD2103A

Typical Performance Characteristics (Cont.)

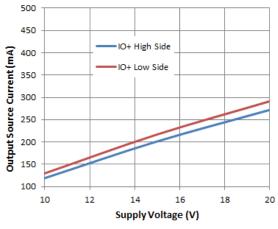


Figure 16. Output Source Current vs. Supply Voltage

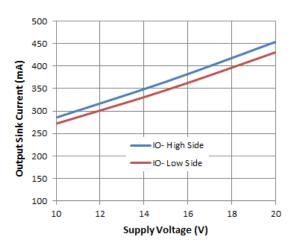


Figure 18. Output Sink Current vs. Supply Voltage

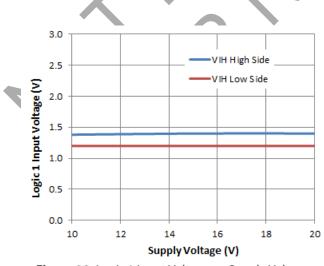


Figure 20. Logic 1 Input Voltage vs. Supply Voltage

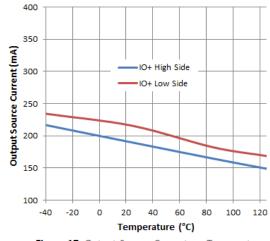
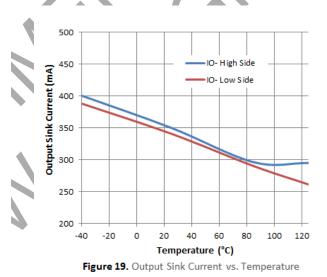


Figure 17. Output Source Current vs. Temperature



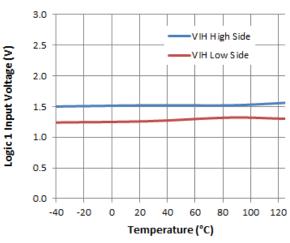
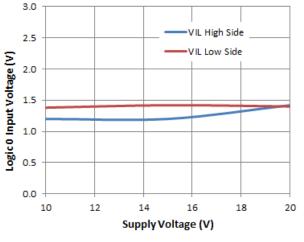


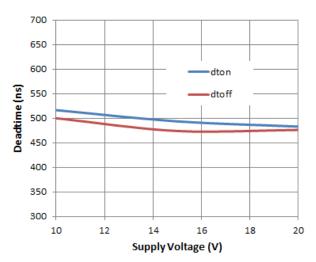
Figure 21. Logic 1 Input Voltage vs. Temperature



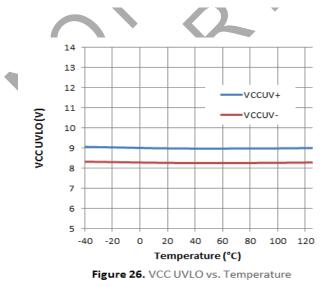
Typical Performance Characteristics (Cont.)

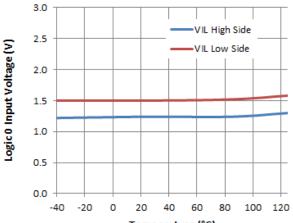












Temperature (°C)

Figure 23. Logic 0 Input Voltage vs. Temperature

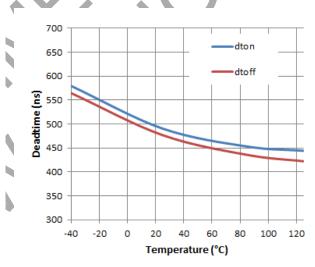


Figure 25. Deadtime vs. Temperature

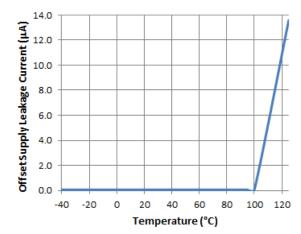


Figure 27. Offset Supply Leakage Current vs. Temperature

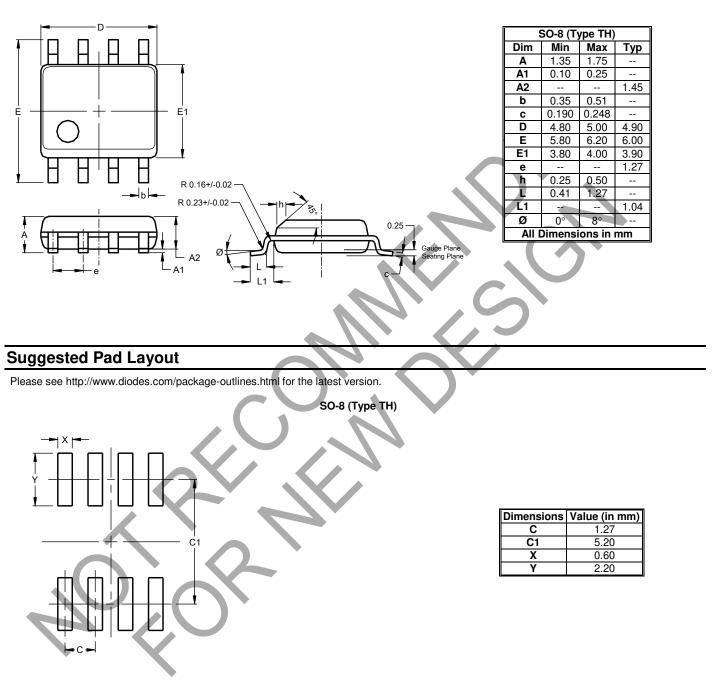


DGD2103A

Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8 (Type TH)



Note: For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device Terminals and PCB tracking.





DGD2103A

IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- A. Life support devices or systems are devices or systems which:
 - 1. are intended to implant into the body, or
 - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2017, Diodes Incorporated

www.diodes.com